

FEATURES

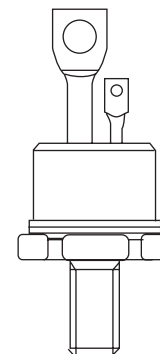
- 1). High current rating
- 2). Excellent dynamic characteristics
- 3). $dv/dt = 1000V/\mu s$ option
- 4). Superior surge capabilities
- 5). Standard package
- 6). Metric threads version available
- 7). Types up to 1600V V_{DRM}/V_{RRM}

TYPICAL APPLICATIONS

- 1). Phase control applications in converters
- 2). Lighting circuits
- 3). Battery charges
- 4). Regulated power supplies and temperature and speed control circuit
- 5). Can be supplied to meet stringent military, aerospace and other high-reliability requirements

MAJOR RATINGS AND CHARACTERISTICS

Parameters		S40RIA		Unit
		10 to 120	140 to 160	
$I_{F(AV)}$		40	40	A
	@ T_C	94	90	°C
$I_{F(RMS)}$		80	80	A
I_{FSM}	@ 50Hz	1430	1200	A
	@ 60Hz	1490	1257	A
i^2t	@ 50Hz	10.18	7.21	KA ² s
	@ 60Hz	9.30	6.58	A ² s
V_{DRM}/V_{RRM}		100 to 1200	1400 to 1600	V
T_q	typical	110		μs
T_J		- 40 to 125		°C



ELECTRICAL SPECIFICATIONS

1). Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak reverse voltage *(1)	V_{RSM} , maximum non-repetitive peak reverse voltage *(2)	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$
		V	V	mA
S40RIA	10	100	150	15
	20	200	300	
	40	400	500	
	60	600	700	
	80	800	900	
	100	1000	1100	
	120	1200	1300	
	140	1400	1500	
	160	1600	1700	

*(1) Units may be broken over non-repetitively in the off-state direction without damage, if di/dt does not exceed 20A/μs

*(2) For voltage pulses with $tp \leq 5ms$

2). Forward Conduction

Parameters		S40RIA		Unit	Conditions		
		10 to 120	140 to 160				
$I_{T(AV)}$	Max. average forward current	40	40	A	180° conduction, half sine wave		
	@ Case temperature	94	90	°C			
$I_{T(RMS)}$	Max. RMS forward current	80	80	A			
I_{TSM}	Max. peak, one-cycle forward, non-repetitive surge current	1430	1200	A	t = 10ms	No voltage	Sinusoidal half wave, Initial $T_J = T_J \text{ max.}$
		1490	1257		t = 8.3ms	reapplied	
		1200	1010		t = 10ms	100% V_{RRM}	
		1255	1057		t = 8.3ms	reapplied	
I^2t	Maximum I^2t for fusing	10.18	7.21	KA ² s	t = 10ms	No voltage	
		9.30	6.58		t = 8.3ms	reapplied	
		7.20	5.10		t = 10ms	100% V_{RRM}	
		6.56	4.65		t = 8.3ms	reapplied	
$I^2\sqrt{t}$	Maximum $I^2\sqrt{t}$ for fusing	101.8	72.1	KA ² √s	t = 0.1 to 10ms, no voltage reapplied		
$V_{T(TO)1}$	Low level value of threshold voltage	0.94	1.02	V	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, $T_J = T_J \text{ max.}$		
$V_{T(TO)2}$	High level value of threshold voltage	1.08	1.17	V	$(I > \pi \times I_{F(AV)})$, $T_J = T_J \text{ max.}$		
r_{T1}	Low level value of forward slope resistance	4.08	4.78	mΩ	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, $T_J = T_J \text{ max.}$		
r_{T2}	High level value of forward slope resistance	3.34	3.97	mΩ	$(I > \pi \times I_{F(AV)})$, $T_J = T_J \text{ max.}$		
V_{TM}	Max. forward voltage drop	1.60	1.78	V	$I_{pk} = 50A$, $T_J = 25^\circ C$, $t_p = 10ms$ sine pulse		
I_H	Maximum holding current	200		mA	$T_J = 25^\circ C$, anode supply 12V resistive load		
I_L	Typical latching current	400					
di/dt	Max. rate of rise of turned-on current			A/μs	$T_C = 125^\circ C$, $V_{DM} = \text{rated } V_{DRM}$		
	VDRM ≤ 600V	200			Gate pulse = 20V, 15Ω, $t_p = 6 \mu s$, tr = 0.1 μs max. $I_{TM} = (2 \times \text{rated } di/dt) A$		
	VDRM ≤ 1600V	100					
t_d	Typical delay time	0.9		μs	$T_C = 25^\circ C$, $V_{DM} = \text{rated } V_{DRM}$, $I_{TM} = 10A$ dc resistive circuit Gate pulse = 10V, 15Ω source, $t_p = 20 \mu s$		
t_q	Typical turn-off time	110			$T_C = 125^\circ C$, $I_{TM} = 50A$, reapplied dv/dt = 20V/μs dir/dt = -10A/μs, VR=50V		
dv/dt	Max. critical rate of rise of off-state voltage	200		V/μs	$T_J = T_J \text{ max.}$ linear to 100% rated V_{DRM}		
		500(*)			$T_J = T_J \text{ max.}$ linear to 67% rated V_{DRM}		

(*) Available with: dv/dt = 1000V/μs, to complete code add S90 i.e. S40RIA120S90.

3). Triggering

Parameters		S40RIA	Unit	Conditions		
P_{GM}	Maximum peak gate power	10	W	$T_J = T_J \text{ max.}$		
$P_{G(AV)}$	Maximum average gate power	2.5				
I_{GM}	Max. peak positive gate current	2.5	A	$T_J = T_J \text{ max.}$		
$+V_{GM}$	Max. peak positive gate current	20	V	$T_J = T_J \text{ max.}$		
$-V_{GM}$	Maximum peak positive gate voltage	10				
I_{GT}	DC gate current required to trigger	250	mA	$T_J = -40^\circ\text{C}$	Max. required gate trigger current/voltage are the lowest value which will trigger all units 6V anode-to-cathode applied	
		100		$T_J = 25^\circ\text{C}$		
		50		$T_J = 125^\circ\text{C}$		
V_{GT}	DC gate voltage required to trigger	3.5	V	$T_J = -40^\circ\text{C}$		
		2.5		$T_J = 25^\circ\text{C}$		
I_{GD}	DC gate current not to trigger	5.0	mA	$T_J = T_J \text{ max.}$		Max. gate current/ voltage not to trigger is the max. value which. will not trigger any unit with rated V_{DRM} anode-to-cathode applied
				$V_{DRM} = \text{rated value}$		
V_{GD}	DC gate voltage not to trigger	0.2	V	$T_J = T_J \text{ max.}$		
T_J	Max. operating temperature range	- 40 to 125	$^\circ\text{C}$			
T_{stg}	Max. storage temperature range	- 40 to 125	$^\circ\text{C}$			
R_{thJC}	Max. thermal resistance, junction to case	0.35	K/W	DC operation		
R_{thCS}	Max. thermal resistance, case to heatsink	0.25	K/W	Mounting surface, smooth, flat and greased		
T	Mounting torque	Min.	2.8 (25)	Nm	Non-lubricated threads	
		Max.	3.4 (30)	lbf-in		
wt	Approximate weight	28 (1.0)	g (oz)			
	Case style	TO-65		See Outline Table		

ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.078	0.057	K/W	$T_J = T_J \text{ max.}$
120°	0.094	0.098		
90°	0.120	0.130		
60°	0.176	0.183		
30°	0.294	0.296		

PERFORMANCE CURVES FIGURE

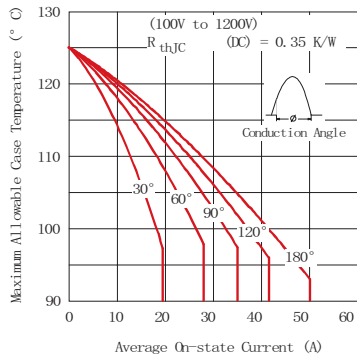


Fig. 1 - Current Ratings Characteristic

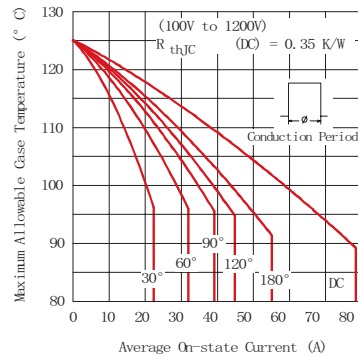


Fig. 2 - Current Ratings Characteristic

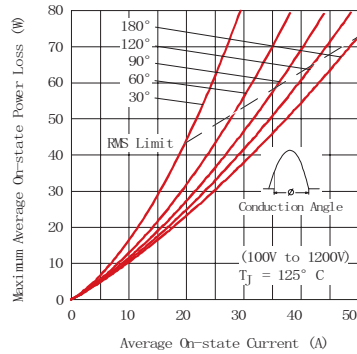


Fig. 3 - On-state Power Loss Characteristics

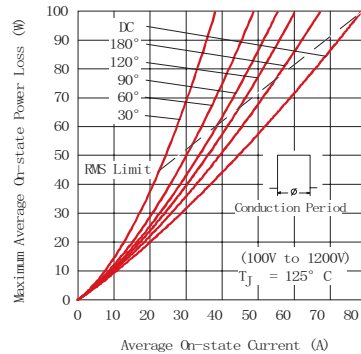


Fig. 4 - On-state Power Loss Characteristics

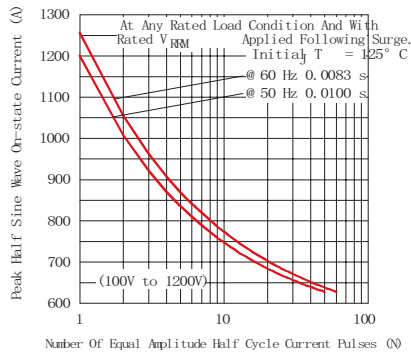


Fig. 5 - Maximum Non-Repetitive Surge Current

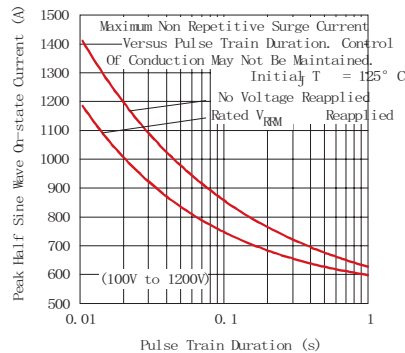


Fig. 6 - Maximum Non-Repetitive Surge Current

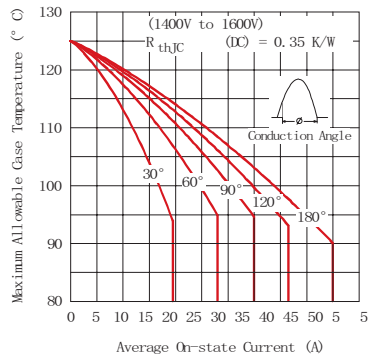


Fig. 7 - Current Ratings Characteristics

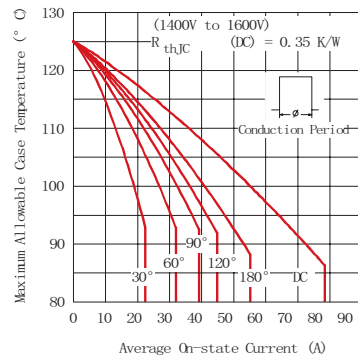


Fig. 8 - Current Ratings Characteristics

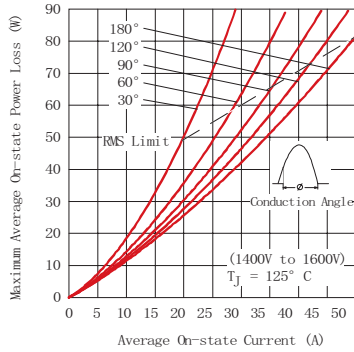


Fig. 9 - On-state Power Loss Characteristics

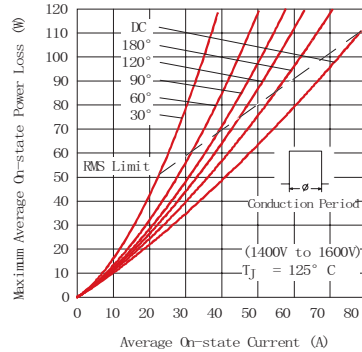


Fig. 10 - On-state Power Loss Characteristics

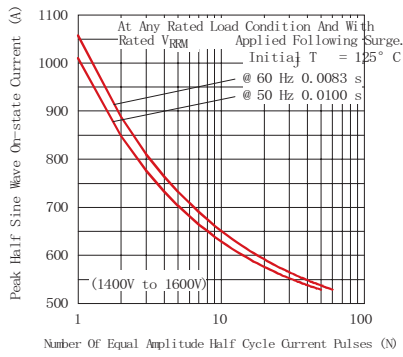


Fig. 11 - Maximum Non-Repetitive Surge Current

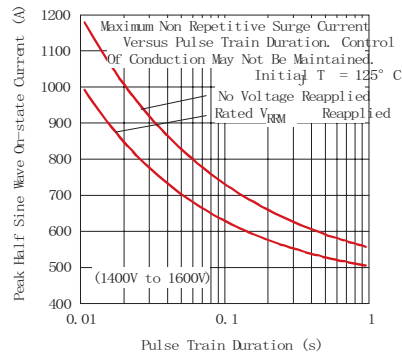


Fig. 12 - Maximum Non-Repetitive Surge Current

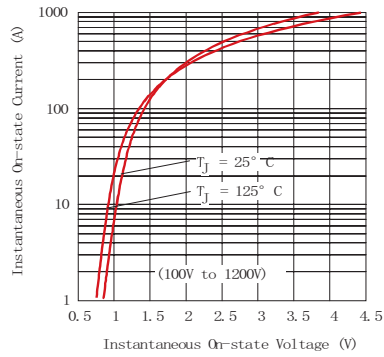


Fig. 13 - Forward Voltage Drop Characteristics

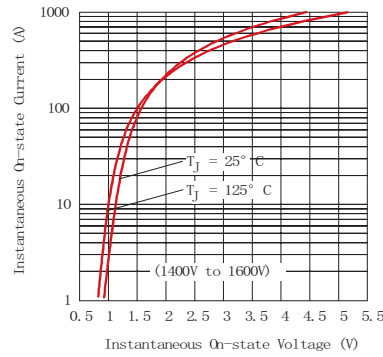


Fig. 14 - Forward Voltage Drop Characteristics

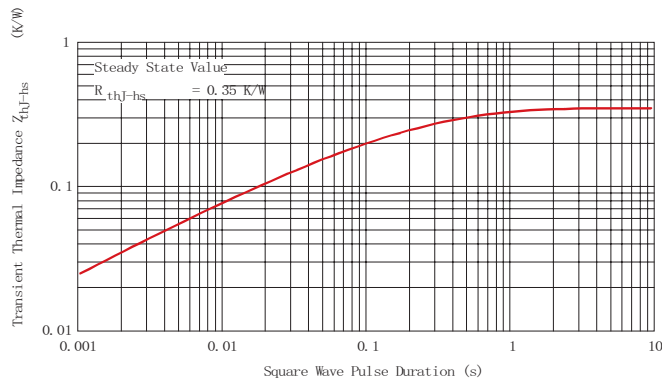


Fig. 15 - Thermal Impedance Z_{thJC} Characteristics

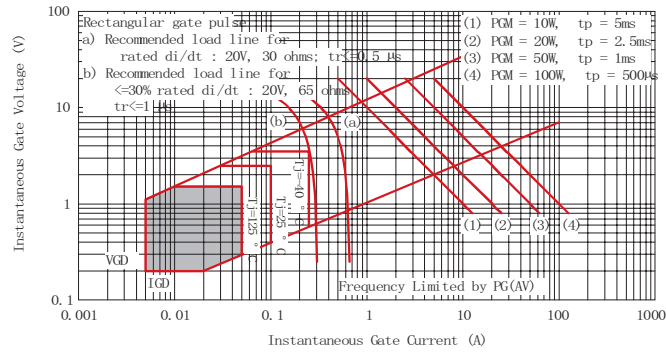


Fig. 16 - Gate Characteristics

OUTLINE

